

客户 (Customer) : \_\_\_\_\_

承认书

Approval Sheet

谨致执事者：兹提供敝公司之有关详细规格及图面数据，敬请给予办理试认定手续。  
同时敬请送返一份附有贵公司签认之测试认定后之样品承认书。

We are pleased in sending you herewith on specification and drawings for your approval.  
Please return to us one copy "Approval sheet" with your approved signature.

型号 (Model No.) : A-SP192YIR1C-A01-4T

发文日期 (Issue Date) : 2022/09/22 承认日期 (Approved Date) : \_\_\_\_\_

Checking signature of Amicc

Designer	Checker	Approver

Approval signature of customer

Designer	Checker	Approver

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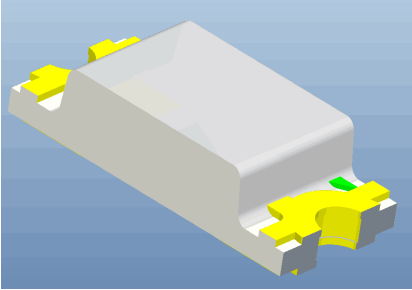
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## Infrared LED ■ Top view 0603 Package

### A-SP192YIR1C-A01-4T



#### Features

- 0603 package
- Top view LED
- Compatible with infrared and vapor phase reflow solder process.
- Wide viewing angle
- Pb-free
- RoHS compliant

#### Description

The Amicc 192Y package has high efficacy, high power consumption, wide viewing angle and a compact form factor. These features make this package an ideal LED for all lighting applications.

#### Applications

- Free air transmission system
- Infrared remote control units with high power requirement
- Smoke detector
- Infrared applied system

#### Device Selection Guide

Chip Materials	Emitted Color	Resin Color
AlGaAs	IR Emitter	Water Clear

**Absolute Maximum Ratings (T<sub>Soldering</sub>=25°C)**

Parameter	Symbol	Rating	Unit
Forward Current	I <sub>F</sub>	20	mA
Reverse Voltage	V <sub>R</sub>	5	V
Operating Temperature	T <sub>opr</sub>	-40 ~ +85	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +85	°C
Power Dissipation at(or below) 25°C Free Air Temperature	P <sub>d</sub>	30	mW
Soldering Temperature	T <sub>sol</sub>	260°C	°C

Note:

\*1: I<sub>FP</sub> Conditions--Pulse Width ≤ 100μs and Duty ≤ 1%.

\*2: Soldering time ≤ 5 seconds.

**Electro-Optical Characteristics (T<sub>Soldering</sub>=25°C)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Radiant Intensity	E <sub>e</sub>	1.25	-----	2.75	mW/sr	I <sub>F</sub> =20mA
Forward Voltage	V <sub>F</sub>	1.0	1.25	1.5	V	I <sub>F</sub> =20mA
Peak Wavelength	λ <sub>p</sub>	-----	940	-----	nm	I <sub>F</sub> =20mA
Viewing Angle	2θ <sub>1/2</sub>	-----	120	-----	deg	I <sub>F</sub> =20mA
Reverse Current	I <sub>R</sub>	-----	-----	10	μA	V <sub>R</sub> =5V

Note:

1.Tolerance of Radiant Intensity: ±10%

2.Tolerance of Forward Voltage: ± 0.1V.

### Bin Range of Radiant Intensity

Bin Code	Min.	Max.	Unit	Condition
A1	1.25	1.75	mW/sr	I <sub>F</sub> =20mA
A2	1.75	2.25		
A3	2.25	2.75		

Note:  
Tolerance of Radiant Intensity: ±10%.

### Bin Range of Forward Voltage

Bin Code	Min.	Max.	Unit	Condition
17	1.0	1.1	V	I <sub>F</sub> =20mA
18	1.1	1.2		
19	1.2	1.3		
20	1.3	1.4		
21	1.4	1.5		

Note:  
Tolerance of Forward Voltage: ± 0.1V.

**Typical Electro-Optical Characteristics Curves**

Fig.1-Forward Current vs. Ambient Temperature

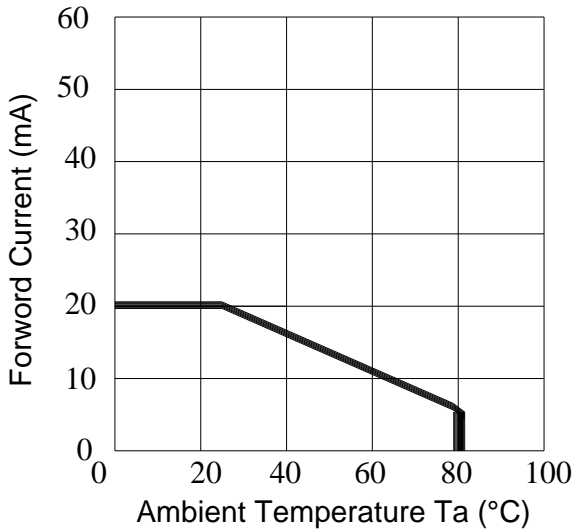


Fig.2-Spectral Sensitivity  
 Ta=25°C

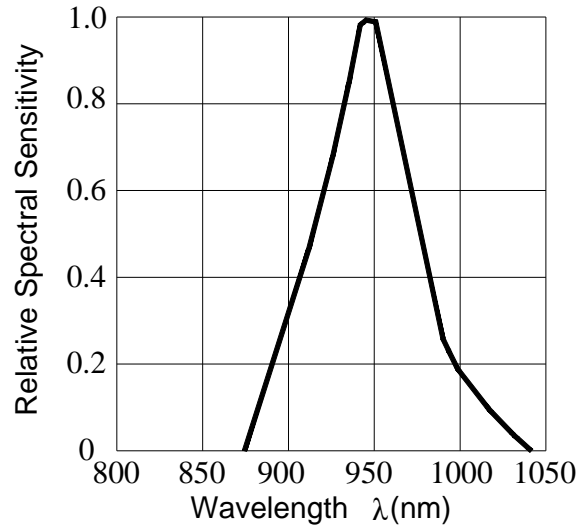


Fig.3-Forward Current vs. Forward Voltage Ta=25°C

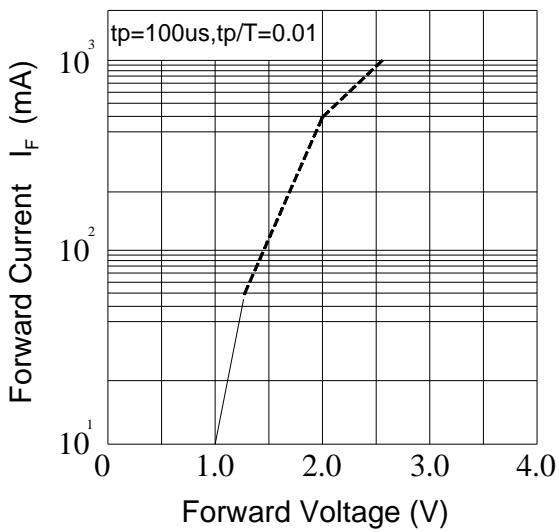
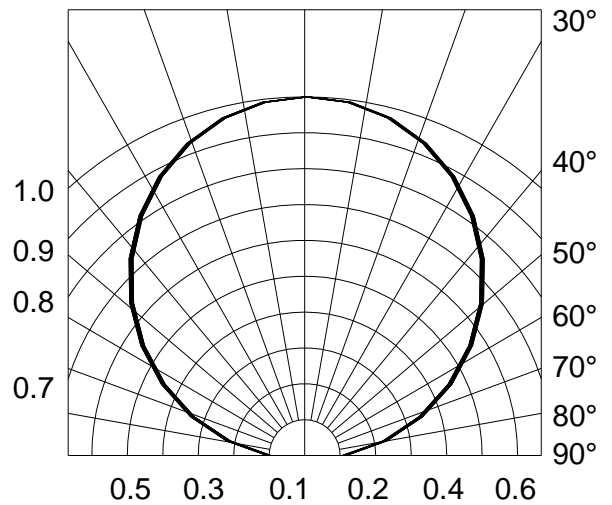


Fig.6-Radiation Diagram Ta=25°C  
 0° 10° 20°



**Typical Electro-Optical Characteristics Curves**

Fig.5-Peak Emission Wavelength vs. Ambient Temperature

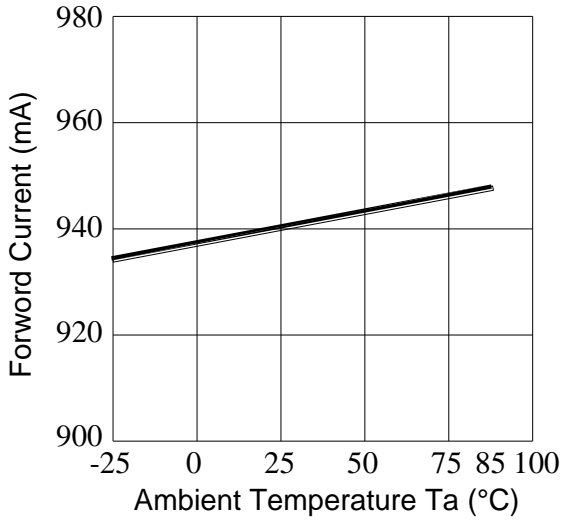


Fig.6-Relative Intensity vs. Forward Current

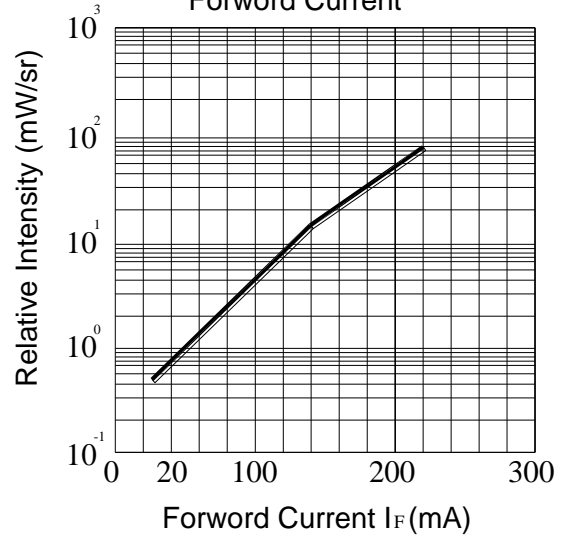


Fig.7-Relative Intensity vs. Ambient Temperature Ta=25°C

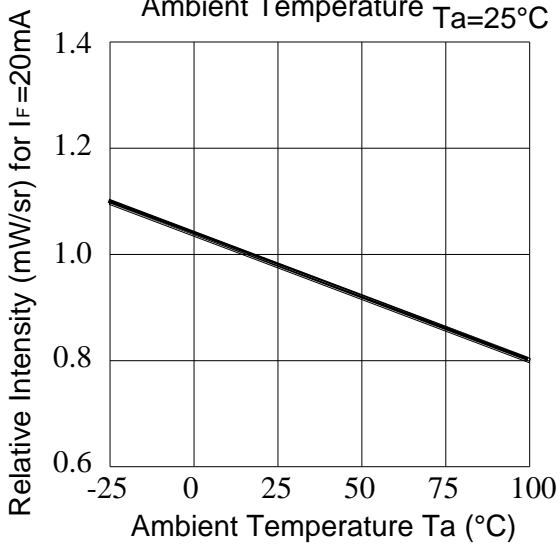
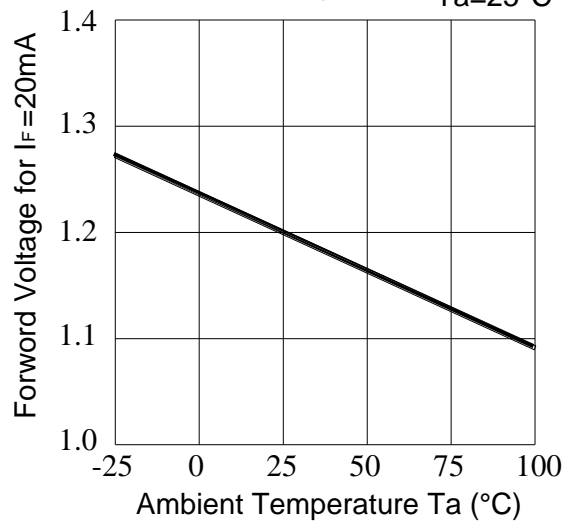
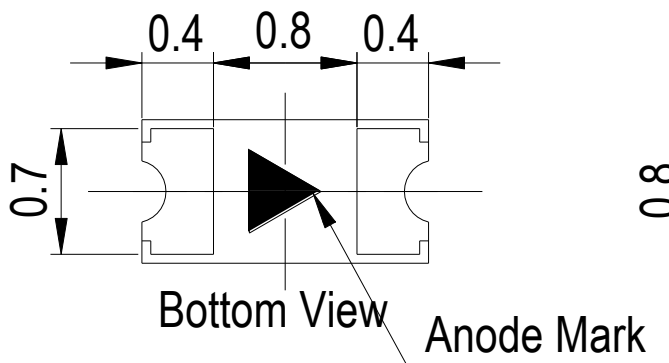
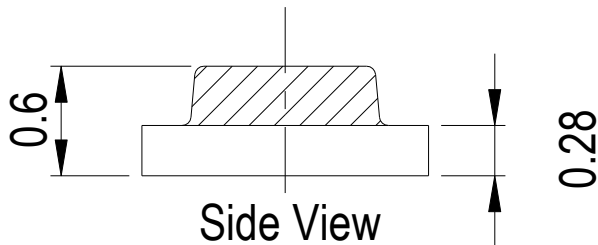
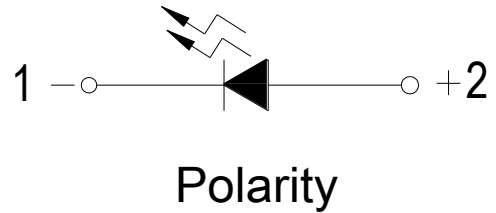
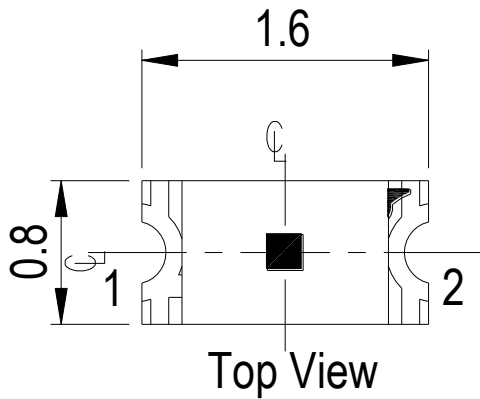


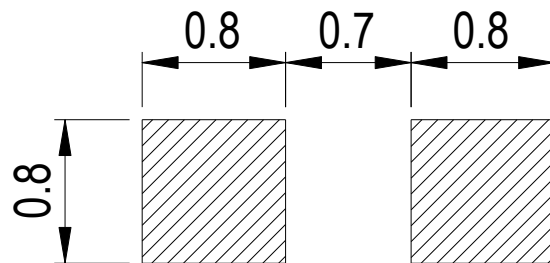
Fig.8-Forward Voltage vs. Ambient Temperature Ta=25°C



**Package Dimension**



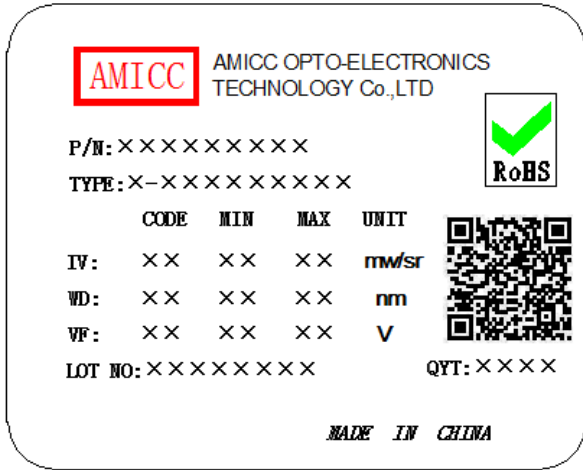
**Recommended Solder Pad**



Note:  
Tolerance unless mentioned is  $\pm 0.1$ mm, Unit = mm.

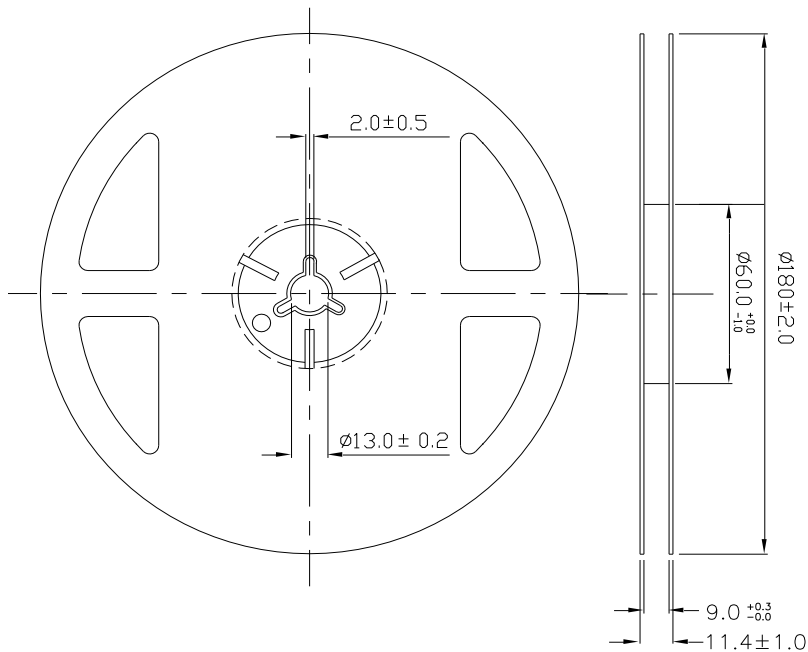
**Moisture Resistant Packing Materials**

**Label Explanation**



- CPN: Customer's Product Number
- P/N: Product Number
- TYPE :Part NO.
- IV: Radiant Intensity Rank
- WD: Dom. Wavelength Rank
- VF: Forward Voltage Rank
- LOT NO.: Lot Number
- QTY: Packing Quantity

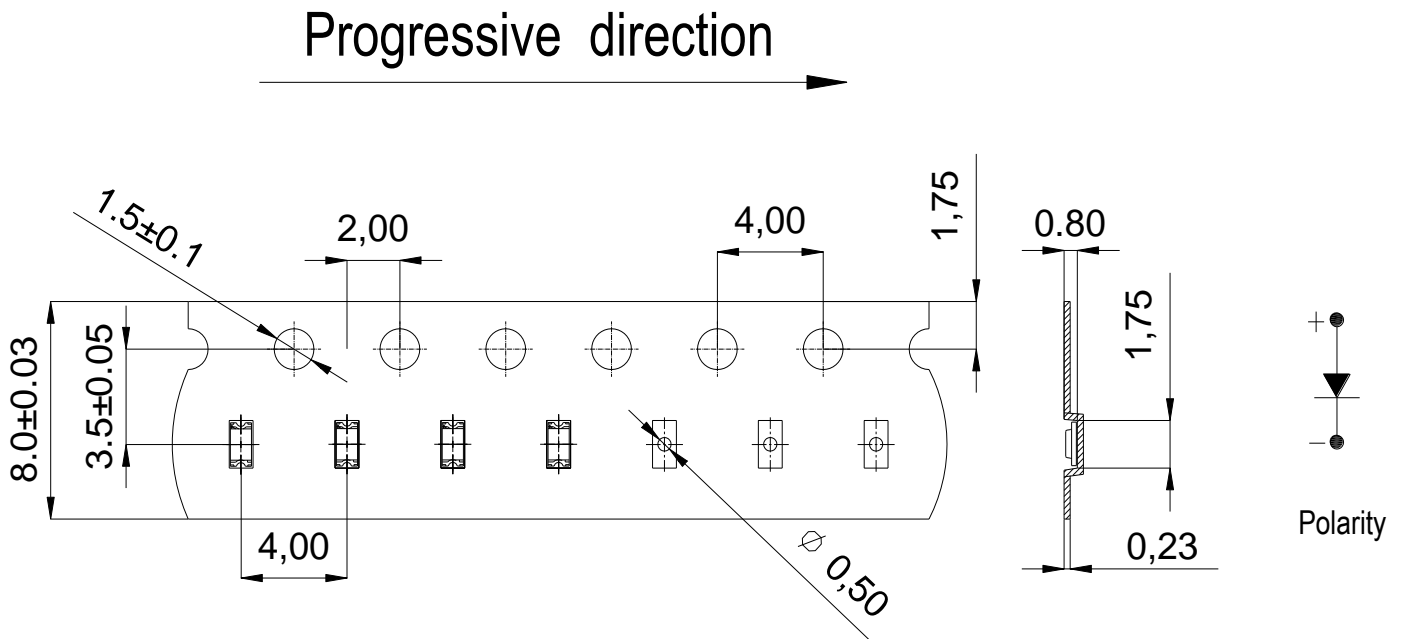
**Reel Dimensions**



Note:  
 Tolerances unless mentioned  $\pm 0.1$ mm, Unit = mm.



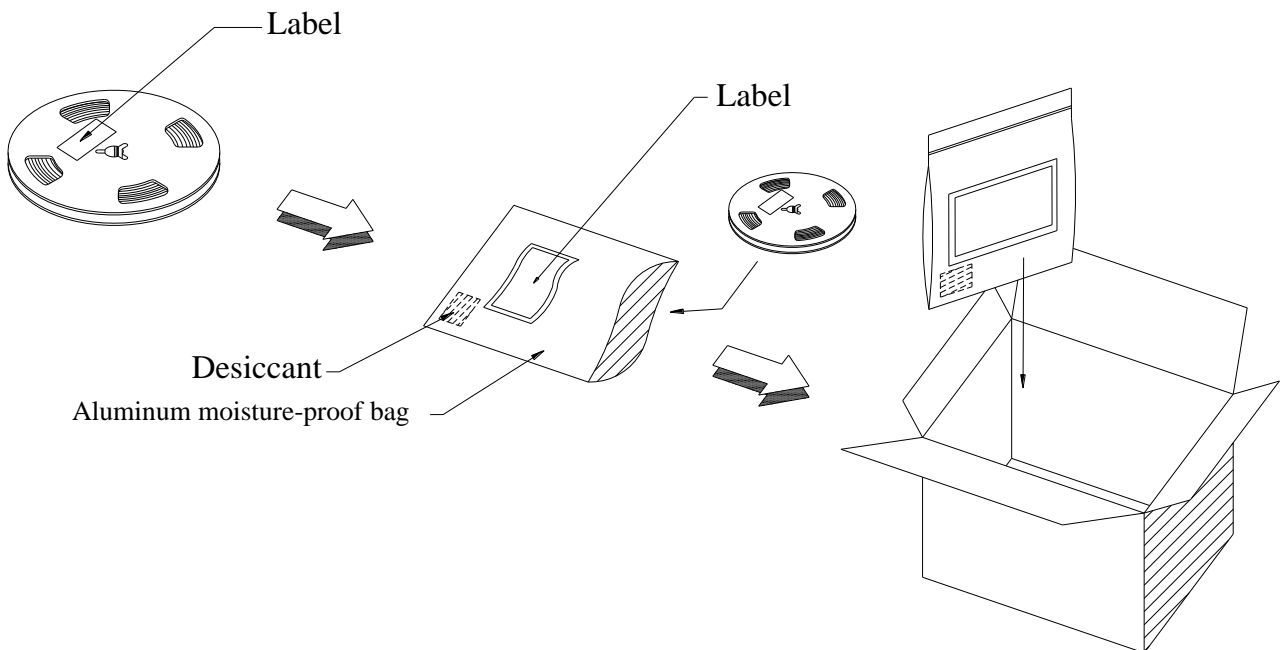
Carrier Tape Dimensions: Loaded Quantity 4000 pcs Per Reel



Note:

1. Tolerance unless mentioned is  $\pm 0.1$  mm, Unit = mm.
2. Minimum packing amount is 1000 pcs per reel.

### Moisture Resistant Packing Process



## Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.  
 Confidence level : 90%  
 LTPD : 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C/10sec.	6 Min.	22 PCS.	0/1
2	Thermal Shock	H : +100°C 5min § 10 sec L : -10°C 5min	300 Cycles	22 PCS.	0/1
3	Temperature Cycle	H : +100°C 15min § 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
4	High Temperature/Humidity	Ta=85°C,85%RH	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Ta=-40°C	1000 Hrs.	22 PCS.	0/1
6	High Temperature Storage	Ta=100°C	1000 Hrs.	22 PCS.	0/1
7	DC Operation Life	Ta=25°C, I <sub>F</sub> = 20 mA	1000 Hrs.	22 PCS.	0/1

## Precautions for Use

### 1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

### 2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

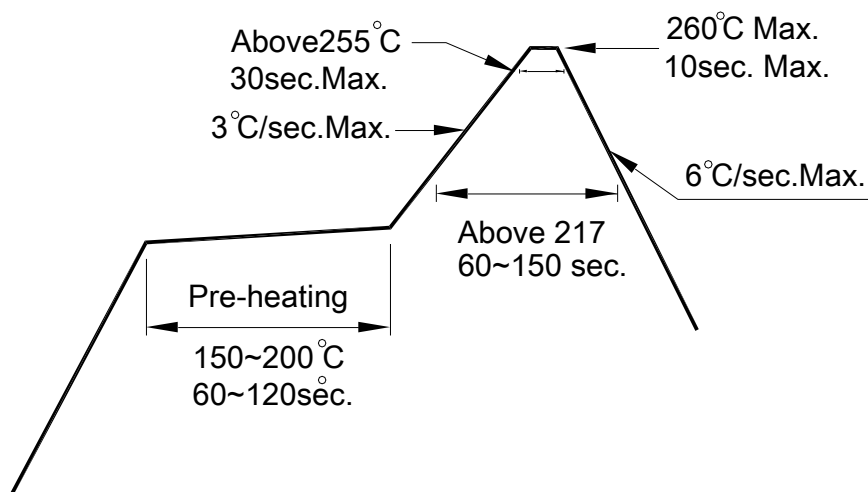
2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5°C for 24 hours.

### 3. Soldering Condition

#### 3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

3.4 After soldering, do not warp the circuit board.

### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of

the LEDs will or will not be damaged by repairing.